# 74LVC1G17

# Single Schmitt trigger buffer Rev. 10 — 29 June 2012

**Product data sheet** 

#### 1. **General description**

The 74LVC1G17 provides a buffer function with Schmitt trigger input. It is capable of transforming slowly changing input signals into sharply defined outputs.

The input can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

#### 2. **Features and benefits**

- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - ◆ JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- $\pm$  24 mA output drive (V<sub>CC</sub> = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Unlimited rise and fall times
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



### 3. Ordering information

Table 1. Ordering information

| Type number | Package           |        |  |          |
|-------------|-------------------|--------|--|----------|
|             | Temperature range | Name   | Description  | Version  |
| 74LVC1G17GW | -40 °C to +125 °C | TSSOP5 | plastic thin shrink small outline package;<br>5 leads; body width 1.25 mm  | SOT353-1 |
| 74LVC1G17GV | –40 °C to +125 °C | SC-74A | plastic surface-mounted package; 5 leads   | SOT753   |
| 74LVC1G17GM | –40 °C to +125 °C | XSON6  | plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm                          | SOT886   |
| 74LVC1G17GF | –40 °C to +125 °C | XSON6  | plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1 \times 0.5$ mm                               | SOT891   |
| 74LVC1G17GN | -40 °C to +125 °C | XSON6  | extremely thin small outline package; no leads; 6 terminals; body 0.9 $\times$ 1.0 $\times$ 0.35 mm                                | SOT1115  |
| 74LVC1G17GS | –40 °C to +125 °C | XSON6  | extremely thin small outline package; no leads; 6 terminals; body 1.0 $\times$ 1.0 $\times$ 0.35 mm                                | SOT1202  |
| 74LVC1G17GX | –40 °C to +125 °C | X2SON5 | X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body $0.8 \times 0.8 \times 0.35$ mm | SOT1226  |

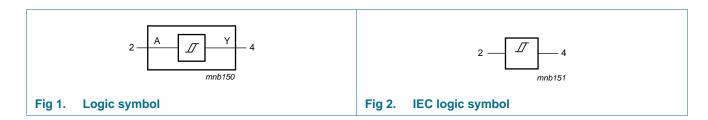
### 4. Marking

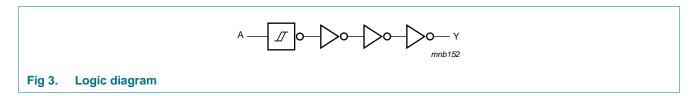
Table 2. Marking codes

| Type number | Marking[1] |
|-------------|------------|
| 74LVC1G17GW | VJ         |
| 74LVC1G17GV | V17        |
| 74LVC1G17GM | VJ         |
| 74LVC1G17GF | VJ         |
| 74LVC1G17GN | VJ         |
| 74LVC1G17GS | VJ         |
| 74LVC1G17GX | VJ         |

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

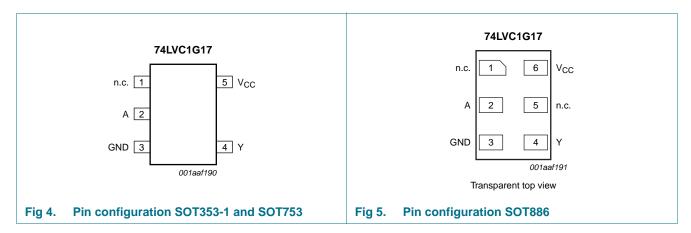
## 5. Functional diagram





### 6. Pinning information

### 6.1 Pinning





### 6.2 Pin description

Table 3. Pin description

| Symbol   | Pin               |       | Description    |
|----------|-------------------|-------|----------------|
|          | TSSOP5 and X2SON5 | XSON6 |                |
| n.c.     | 1                 | 1, 5  | not connected  |
| A        | 2                 | 2     | data input     |
| GND      | 3                 | 3     | ground (0 V)   |
| Υ        | 4                 | 4     | data output    |
| $V_{CC}$ | 5                 | 6     | supply voltage |

Single Schmitt trigger buffer

### 7. Functional description

Table 4. Function table[1]

| Input | Output |
|-------|--------|
| A     | Υ      |
| L     | L      |
| Н     | Н      |

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level

### 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

|                  |                         | <b>3</b> , , , , ,   |                     | 1.0            | ,    |
|------------------|-------------------------|--|---------------------|----------------|------|
| Symbol           | Parameter               | Conditions   | Min                 | Max            | Unit |
| $V_{CC}$         | supply voltage          |  | -0.5                | +6.5           | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < 0 V   | -50                 | -              | mA   |
| VI               | input voltage           |  | [ <u>1</u> ] -0.5   | +6.5           | V    |
| I <sub>OK</sub>  | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V                                      | -                   | ±50            | mA   |
| Vo               | output voltage          | Active mode  | [ <u>1][2]</u> –0.5 | $V_{CC} + 0.5$ | V    |
|                  |                         | Power-down mode  | [ <u>1][2]</u> –0.5 | +6.5           | V    |
| I <sub>O</sub>   | output current          | $V_O = 0 V to V_{CC}$  | -                   | ±50            | mA   |
| I <sub>CC</sub>  | supply current          |  | -                   | 100            | mA   |
| I <sub>GND</sub> | ground current          |  | -100                | -              | mA   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ | <u>[3]</u> _        | 250            | mW   |
| T <sub>stg</sub> | storage temperature     |  | -65                 | +150           | °C   |
|                  |                         |  |                     |                |      |

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### 9. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol           | Parameter           | Conditions                             | Min  | Тур | Max      | Unit |
|------------------|---------------------|--|------|-----|----------|------|
| $V_{CC}$         | supply voltage      |  | 1.65 | -   | 5.5      | V    |
| $V_{I}$          | input voltage       |  | 0    | -   | 5.5      | V    |
| Vo               | output voltage      | Active mode                            | 0    | -   | $V_{CC}$ | V    |
|                  |                     | V <sub>CC</sub> = 0 V; Power-down mode | 0    | -   | 5.5      | V    |
| T <sub>amb</sub> | ambient temperature |  | -40  | -   | +125     | °C   |

<sup>[2]</sup> When  $V_{CC} = 0 \text{ V}$  (Power-down mode), the output voltage can be 5.5 V in normal operation.

<sup>[3]</sup> For TSSOP5 and SC-74A packages: above 87.5 °C the value of P<sub>tot</sub> derates linearly with 4.0 mW/K. For XSON6 and X2SON5 package: above 118 °C the value of P<sub>tot</sub> derates linearly with 7.8 mW/K.

### 10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol               | Parameter                 | Conditions  | Min                   | Typ[1] | Max  | Uni |
|----------------------|---------------------------|---|-----------------------|--------|------|-----|
| T <sub>amb</sub> = - | 40 °C to +85 °C           |   |                       |        |      |     |
| V <sub>OH</sub>      | HIGH-level output voltage | $V_I = V_{T+}$ or $V_{T-}$  |                       |        |      |     |
|                      |                           | $I_O = -100 \ \mu A; \ V_{CC} = 1.65 \ V \ to \ 5.5 \ V$  | V <sub>CC</sub> - 0.1 | -      | -    | V   |
|                      |                           | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$  | 1.2                   | -      | -    | V   |
|                      |                           | $I_{O} = -8$ mA; $V_{CC} = 2.3$ V   | 1.9                   | -      | -    | V   |
|                      |                           | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$  | 2.2                   | -      | -    | V   |
|                      |                           | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$  | 2.3                   | -      | -    | V   |
|                      |                           | $I_{O} = -32$ mA; $V_{CC} = 4.5$ V  | 3.8                   | -      | -    | V   |
| V <sub>OL</sub>      | LOW-level output voltage  | $V_I = V_{T+}$ or $V_{T-}$  |                       |        |      |     |
|                      |                           | $I_O = 100 \mu A$ ; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$   | -                     | -      | 0.1  | V   |
|                      |                           | $I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$   | -                     | -      | 0.45 | V   |
|                      |                           | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$  | -                     | -      | 0.3  | V   |
|                      |                           | $I_{O} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$   | -                     | -      | 0.4  | V   |
|                      |                           | $I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$   | -                     | -      | 0.55 | V   |
|                      |                           | $I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$   | -                     | -      | 0.55 | V   |
| l <sub>l</sub>       | input leakage current     | $V_I = 5.5 \text{ V or GND}$ ; $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$   | -                     | ±0.1   | ±5   | μΑ  |
| OFF                  | power-off leakage current | $V_{I}$ or $V_{O} = 5.5 \text{ V}$ ; $V_{CC} = 0 \text{ V}$   | -                     | ±0.1   | ±10  | μΑ  |
| I <sub>CC</sub>      | supply current            | V <sub>I</sub> = 5.5 V or GND;<br>V <sub>CC</sub> = 1.65 V to 5.5 V; I <sub>O</sub> = 0 A                                 | -                     | 0.1    | 10   | μΑ  |
| ∆l <sub>CC</sub>     | additional supply current | $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$<br>$V_{CC} = 2.3 \text{ V} \text{ to } 5.5 \text{ V}; \text{ per pin}$ | -                     | 5      | 500  | μΑ  |
| Cı                   | input capacitance         |   | -                     | 5      | -    | pF  |
| T <sub>amb</sub> = - | 40 °C to +125 °C          |   |                       |        |      |     |
| V <sub>ОН</sub>      | HIGH-level output voltage | $V_I = V_{T+}$ or $V_{T-}$  |                       |        |      |     |
|                      |                           | $I_O = -100 \mu A$ ; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$  | V <sub>CC</sub> – 0.1 | -      | -    | V   |
|                      |                           | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$  | 0.95                  | -      | -    | V   |
|                      |                           | $I_O = -8$ mA; $V_{CC} = 2.3$ V   | 1.7                   | -      | -    | V   |
|                      |                           | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$  | 1.9                   | -      | -    | V   |
|                      |                           | $I_O = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$  | 2.0                   | -      | -    | V   |
|                      |                           | $I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$  | 3.4                   | -      | -    | V   |
| V <sub>OL</sub>      | LOW-level output voltage  | $V_I = V_{T+}$ or $V_{T-}$  |                       |        |      |     |
|                      |                           | $I_O = 100 \mu A$ ; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$   | -                     | -      | 0.1  | V   |
|                      |                           | $I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$   | -                     | -      | 0.7  | V   |
|                      |                           | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$  | -                     | -      | 0.45 | V   |
|                      |                           | $I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$   | -                     | -      | 0.6  | V   |
|                      |                           | $I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$   | -                     | -      | 0.80 | V   |
|                      |                           | $I_O = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$   | -                     | -      | 0.80 | V   |
| l <sub>l</sub>       | input leakage current     | $V_1 = 5.5 \text{ V or GND}; V_{CC} = 0 \text{ V to } 5.5 \text{ V}$  |                       |        | ±100 | μΑ  |

 Table 7.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions  | Min | Typ[1] | Max  | Unit |
|-----------------|---------------------------|---|-----|--------|------|------|
| $I_{OFF}$       | power-off leakage current | $V_1$ or $V_O = 5.5$ V; $V_{CC} = 0$ V  | -   | -      | ±200 | μΑ   |
| I <sub>CC</sub> | supply current            | $V_I = 5.5 \text{ V or GND};$<br>$V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}; I_O = 0 \text{ A}$   | -   | -      | 200  | μА   |
| $\Delta I_{CC}$ | additional supply current | per pin; $V_I = V_{CC} - 0.6 \text{ V}$ ; $I_O = 0 \text{ A}$ ; $V_{CC} = 2.3 \text{ V}$ to 5.5 V | -   | -      | 5000 | μΑ   |

<sup>[1]</sup> All typical values are measured at maximum  $V_{CC}$  and  $T_{amb}$  = 25  $^{\circ}C.$ 

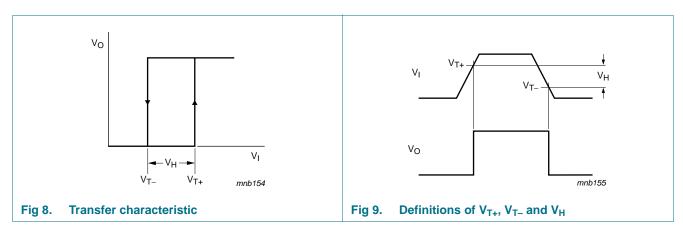
Table 8. Transfer characteristics

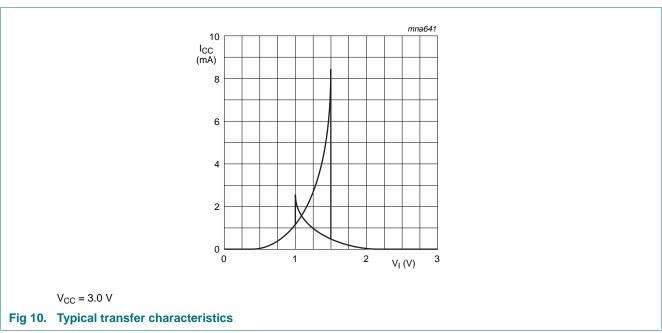
At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol         | Parameter                           | Conditions                           | -40  | -40 °C to +85 °C |      |      | -40 °C to +125 °C |   |  |
|----------------|-------------------------------------|--------------------------------------|------|------------------|------|------|-------------------|---|--|
|                |                                     |                                      | Min  | Typ[1]           | Max  | Min  | Max               |   |  |
| $V_{T+}$       | positive-going                      | see Figure 8 and Figure 9            | '    | •                | 1    | '    | •                 |   |  |
|                | threshold voltage                   | V <sub>CC</sub> = 1.8 V              | 0.82 | 1.0              | 1.14 | 0.79 | 1.14              | V |  |
|                |                                     | V <sub>CC</sub> = 2.3 V              | 1.03 | 1.2              | 1.40 | 1.00 | 1.40              | V |  |
|                |                                     | V <sub>CC</sub> = 3.0 V              | 1.29 | 1.5              | 1.71 | 1.26 | 1.71              | V |  |
|                |                                     | $V_{CC} = 4.5 \text{ V}$             | 1.84 | 2.1              | 2.36 | 1.81 | 2.36              | V |  |
|                |                                     | $V_{CC} = 5.5 \text{ V}$             | 2.19 | 2.5              | 2.79 | 2.16 | 2.79              | V |  |
| $V_{T-}$       | negative-going<br>threshold voltage | see Figure 8 and Figure 9            |      |                  |      |      |                   |   |  |
|                |                                     | $V_{CC} = 1.8 \text{ V}$             | 0.46 | 0.6              | 0.75 | 0.46 | 0.78              | V |  |
|                |                                     | V <sub>CC</sub> = 2.3 V              | 0.65 | 0.8              | 0.96 | 0.65 | 0.99              | V |  |
|                |                                     | $V_{CC} = 3.0 \text{ V}$             | 0.88 | 1.0              | 1.24 | 0.88 | 1.27              | V |  |
|                |                                     | V <sub>CC</sub> = 4.5 V              | 1.32 | 1.5              | 1.84 | 1.32 | 1.87              | V |  |
|                |                                     | V <sub>CC</sub> = 5.5 V              | 1.58 | 1.8              | 2.24 | 1.58 | 2.27              | V |  |
| V <sub>H</sub> | hysteresis<br>voltage               | see Figure 8, Figure 9 and Figure 10 |      |                  |      |      |                   |   |  |
|                |                                     | V <sub>CC</sub> = 1.8 V              | 0.26 | 0.4              | 0.51 | 0.19 | 0.51              | V |  |
|                |                                     | V <sub>CC</sub> = 2.3 V              | 0.28 | 0.4              | 0.57 | 0.22 | 0.57              | V |  |
|                |                                     | V <sub>CC</sub> = 3.0 V              | 0.31 | 0.5              | 0.64 | 0.25 | 0.64              | V |  |
|                |                                     | V <sub>CC</sub> = 4.5 V              | 0.40 | 0.6              | 0.77 | 0.34 | 0.77              | V |  |
|                |                                     | V <sub>CC</sub> = 5.5 V              | 0.47 | 0.6              | 0.88 | 0.41 | 0.88              | V |  |

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

### 10.1 Transfer characteristic waveforms





### 11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 12.

| Symbol   | Parameter                     | Conditions  |     | -40 | °C to +85 | o °C | –40 °C to | +125 °C | Unit |
|----------|-------------------------------|---|-----|-----|-----------|------|-----------|---------|------|
|          |                               |   |     | Min | Typ[1]    | Max  | Min       | Max     |      |
| $t_{pd}$ | propagation delay             | A to Y; see Figure 11                                       | [2] |     |           |      |           |         |      |
|          |                               | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$                |     | 1.0 | 4.1       | 11.0 | 1.0       | 14.0    | ns   |
|          |                               | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$                  |     | 0.7 | 2.8       | 6.5  | 0.7       | 8.5     | ns   |
|          |                               | $V_{CC} = 2.7 \text{ V}$                                    |     | 0.7 | 3.2       | 6.5  | 0.7       | 8.5     | ns   |
|          |                               | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$                  |     | 0.7 | 3.0       | 5.5  | 0.7       | 7.0     | ns   |
|          |                               | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$                  |     | 0.7 | 2.2       | 5.0  | 0.7       | 6.5     | ns   |
| $C_{PD}$ | power dissipation capacitance | $V_I = GND \text{ to } V_{CC};$<br>$V_{CC} = 3.3 \text{ V}$ | [3] | -   | 16.6      | -    | -         | -       | pF   |

- [1] Typical values are measured at  $T_{amb} = 25$  °C and  $V_{CC} = 1.8$  V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

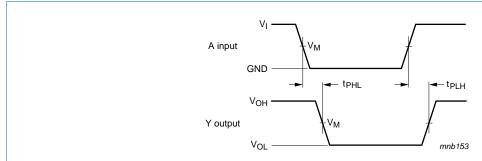
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

#### 12. Waveforms



Measurement points are given in Table 10.

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical output voltage levels that occur with the output load.

Fig 11. The input A to output Y propagation delay times

Table 10. Measurement points

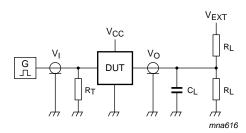
| Supply voltage   | Input               | Output              |
|------------------|---------------------|---------------------|
| V <sub>CC</sub>  | V <sub>M</sub>      | V <sub>M</sub>      |
| 1.65 V to 1.95 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 2.3 V to 2.7 V   | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |

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Table 10. Measurement points ...continued

| Supply voltage  | Input               | Output              |
|-----------------|---------------------|---------------------|
| V <sub>CC</sub> | V <sub>M</sub>      | V <sub>M</sub>      |
| 2.7 V           | 1.5 V               | 1.5 V               |
| 3.0 V to 3.6 V  | 1.5 V               | 1.5 V               |
| 4.5 V to 5.5 V  | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |



Test data is given in Table 11.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

 $V_{EXT}$  = External voltage for measuring switching times.

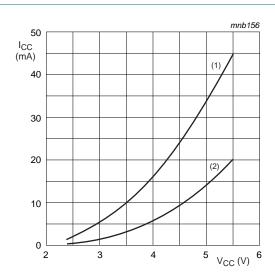
Fig 12. Test circuit for measuring switching times

Table 11. Test data

| Supply voltage   | Input          |             | Load  |                | V <sub>EXT</sub>                    |
|------------------|----------------|-------------|-------|----------------|-------------------------------------|
| V <sub>CC</sub>  | V <sub>I</sub> | $t_r = t_f$ | CL    | R <sub>L</sub> | t <sub>PLH</sub> , t <sub>PHL</sub> |
| 1.65 V to 1.95 V | $V_{CC}$       | ≤ 2.0 ns    | 30 pF | 1 kΩ           | open                                |
| 2.3 V to 2.7 V   | $V_{CC}$       | ≤ 2.0 ns    | 30 pF | 500 Ω          | open                                |
| 2.7 V            | 2.7 V          | ≤ 2.5 ns    | 50 pF | 500 Ω          | open                                |
| 3.0 V to 3.6 V   | 2.7 V          | ≤ 2.5 ns    | 50 pF | 500 Ω          | open                                |
| 4.5 V to 5.5 V   | $V_{CC}$       | ≤ 2.5 ns    | 50 pF | 500 Ω          | open                                |

## 13. Application information

### Single Schmitt trigger buffer



Linear change of V<sub>I</sub> between 0.8 V to 2.0 V.

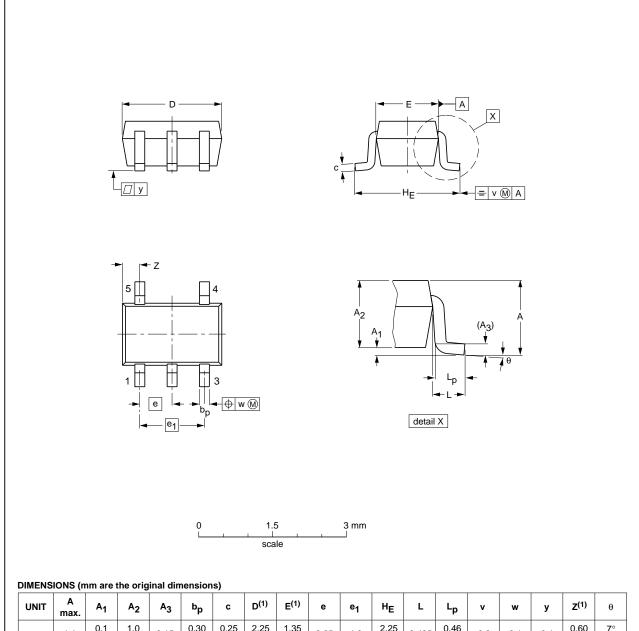
- (1) Positive-going edge.
- (2) Negative-going edge.

Fig 13. Average supply current as a function of supply voltage

### 14. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | bp           | С            | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | e <sub>1</sub> | HE          | L     | Lp           | v   | w   | у   | Z <sup>(1)</sup> | θ        |
|------|-----------|----------------|----------------|----------------|--------------|--------------|------------------|------------------|------|----------------|-------------|-------|--------------|-----|-----|-----|------------------|----------|
| mm   | 1.1       | 0.1<br>0       | 1.0<br>0.8     | 0.15           | 0.30<br>0.15 | 0.25<br>0.08 | 2.25<br>1.85     | 1.35<br>1.15     | 0.65 | 1.3            | 2.25<br>2.0 | 0.425 | 0.46<br>0.21 | 0.3 | 0.1 | 0.1 | 0.60<br>0.15     | 7°<br>0° |

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

|     | REFER  | EUROPEAN  | ISSUE DATE |                 |                                  |
|-----|--------|-----------|------------|-----------------|----------------------------------|
| IEC | JEDEC  | JEITA     |            | PROJECTION      | 1330E DATE                       |
|     | MO-203 | SC-88A    |            |                 | <del>-00-09-01</del><br>03-02-19 |
|     | IEC    | IEC JEDEC |            | IEC JEDEC JEITA | IEC JEDEC JEITA PROJECTION       |

Fig 14. Package outline SOT353-1 (TSSOP5)

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### Plastic surface-mounted package; 5 leads

**SOT753** 

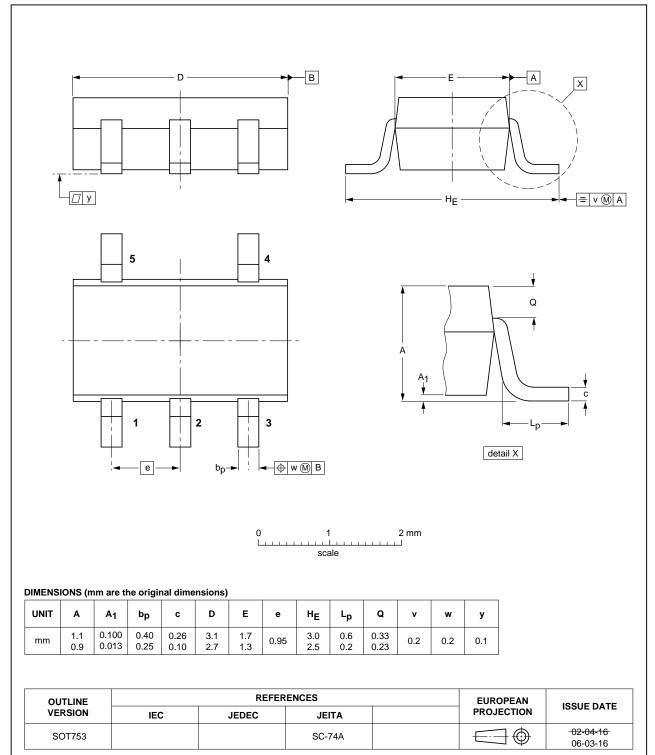


Fig 15. Package outline SOT753 (SC-74A)

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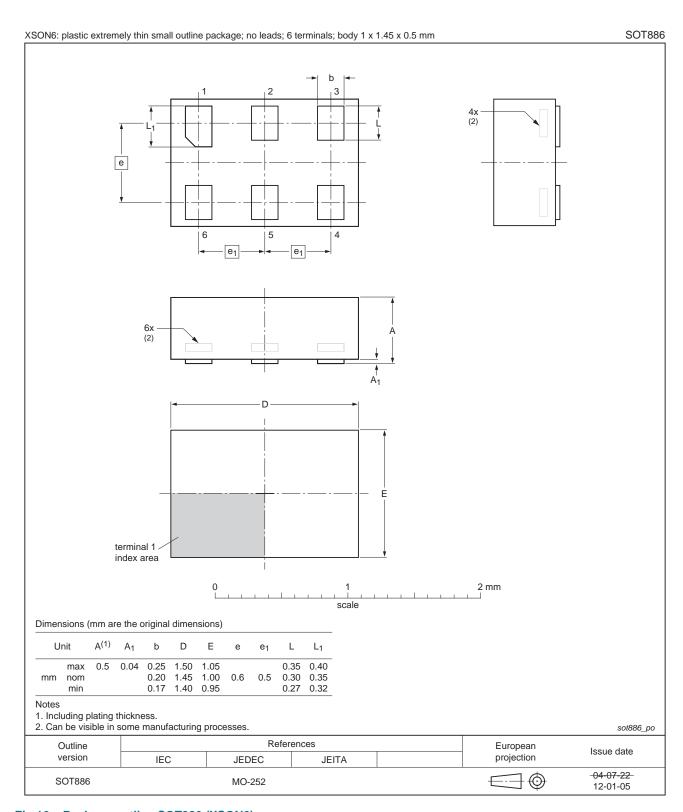


Fig 16. Package outline SOT886 (XSON6)

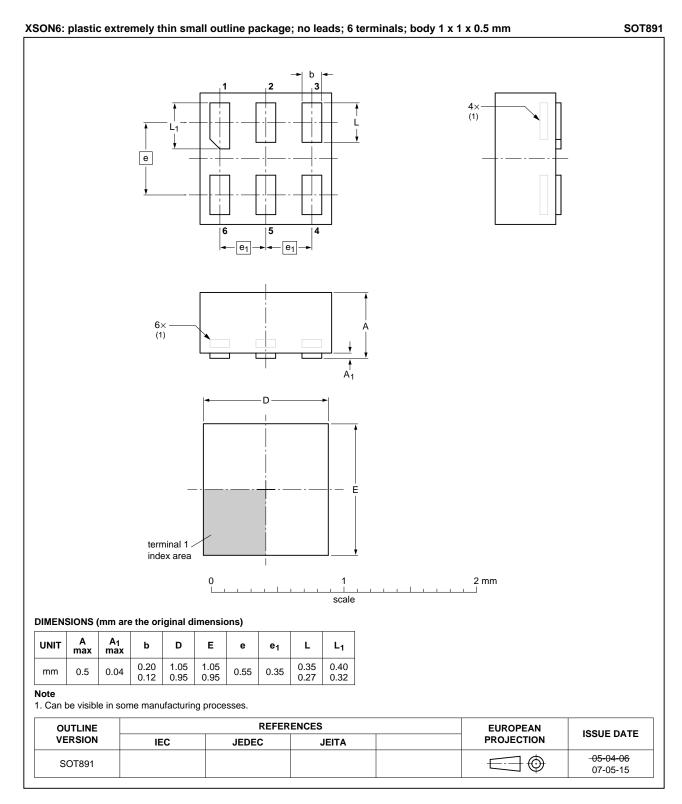


Fig 17. Package outline SOT891 (XSON6)

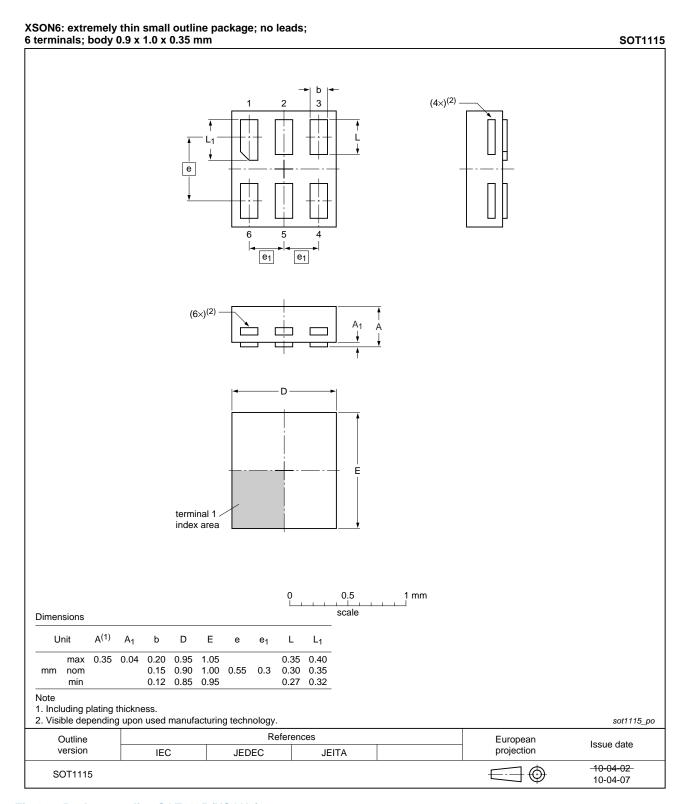


Fig 18. Package outline SOT1115 (XSON6)

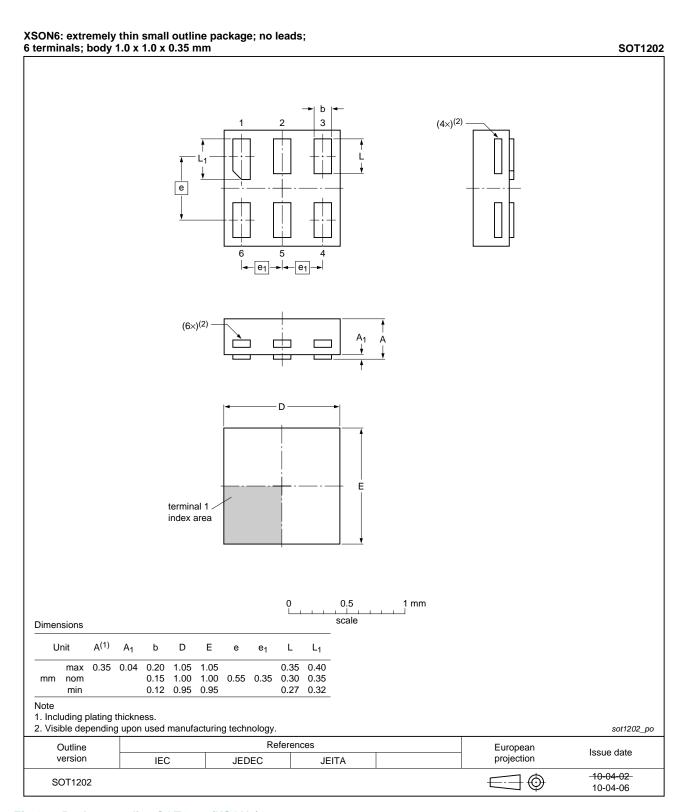


Fig 19. Package outline SOT1202 (XSON6)

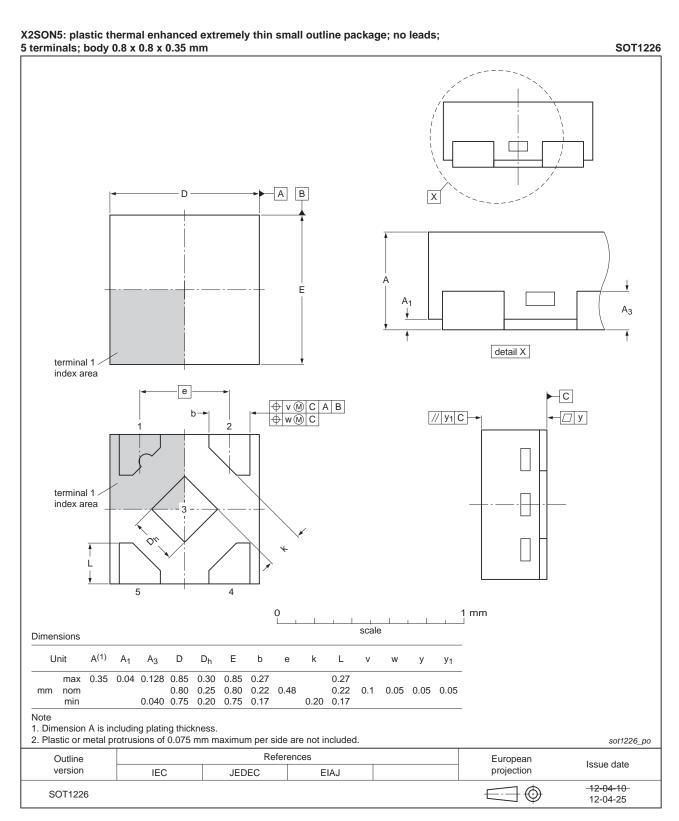


Fig 20. Package outline SOT1226 (X2SON5)

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### 15. Abbreviations

#### Table 12. Abbreviations

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| НВМ     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

### 16. Revision history

#### Table 13. Revision history

|                | -                               |                             |                     |               |
|----------------|---------------------------------|-----------------------------|---------------------|---------------|
| Document ID    | Release date                    | Data sheet status           | Change notice       | Supersedes    |
| 74LVC1G17 v.10 | 20120629                        | Product data sheet          | -                   | 74LVC1G17 v.9 |
| Modifications: | <ul> <li>Added type</li> </ul>  | number 74LVC1G17GX (S       | OT1226)             |               |
|                | <ul> <li>Package ou</li> </ul>  | ıtline drawing of SOT886 (F | igure 16) modified. |               |
| 74LVC1G17 v.9  | 20111206                        | Product data sheet          | -                   | 74LVC1G17 v.8 |
| Modifications: | <ul> <li>Legal pages</li> </ul> | s updated.                  |                     |               |
| 74LVC1G17 v.8  | 20110920                        | Product data sheet          | -                   | 74LVC1G17 v.7 |
| 74LVC1G17 v.7  | 20101110                        | Product data sheet          | -                   | 74LVC1G17 v.6 |
| 74LVC1G17 v.6  | 20070827                        | Product data sheet          | -                   | 74LVC1G17 v.5 |
| 74LVC1G17 v.5  | 20061006                        | Product data sheet          | -                   | 74LVC1G17 v.4 |
| 74LVC1G17 v.4  | 20041130                        | Product specification       | -                   | 74LVC1G17 v.3 |
| 74LVC1G17 v.3  | 20041018                        | Product specification       | -                   | 74LVC1G17 v.2 |
| 74LVC1G17 v.2  | 20040407                        | Product specification       | -                   | 74LVC1G17 v.1 |
| 74LVC1G17 v.1  | 20040324                        | Product specification       | -                   | -             |
|                |                                 |                             |                     |               |

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| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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